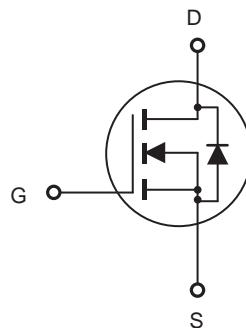


## N-Channel Enhancement Mode Field Effect Transistor

PRELIMINARY

## FEATURES

- 30V, 197A,  $R_{DS(ON)} = 2 \text{ m}\Omega$  @  $V_{GS} = 10\text{V}$ .  
 $R_{DS(ON)} = 3 \text{ m}\Omega$  @  $V_{GS} = 4.5\text{V}$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handing capability.
- Lead-free plating ; RoHS compliant.
- TO-220 & TO-263 package.

CEB SERIES  
TO-263(DD-PAK)CEP SERIES  
TO-220ABSOLUTE MAXIMUM RATINGS  $T_C = 25^\circ\text{C}$  unless otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous @ $T_C = 25^\circ\text{C}$ @ $T_C = 100^\circ\text{C}$	$I_D$	197 124	A
Drain Current-Pulsed <sup>a</sup>	$I_{DM}$	788	A
Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$ - Derate above $25^\circ\text{C}$	$P_D$	139 1.1	W W/ $^\circ\text{C}$
Single Pulsed Avalanche Energy <sup>d</sup>	$E_{AS}$	800	mJ
Single Pulsed Avalanche Current <sup>d</sup>	$I_{AS}$	40	A
Operating and Store Temperature Range	$T_J, T_{stg}$	-55 to 150	$^\circ\text{C}$

## Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	$R_{JC}$	0.9	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient	$R_{JA}$	62.5	$^\circ\text{C/W}$

This is preliminary information on a new product in development now .  
 Details are subject to change without notice .

Rev 1. 2012.Jun  
<http://www.cetsemi.com>



# CEP20A03/CEB20A03

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 250\mu\text{A}$	30			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 30\text{V}, V_{\text{GS}} = 0\text{V}$			1	$\mu\text{A}$
Gate Body Leakage Current, Forward	$I_{\text{GSSF}}$	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$			100	nA
Gate Body Leakage Current, Reverse	$I_{\text{GSSR}}$	$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$			-100	nA
<b>On Characteristics<sup>b</sup></b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}} = V_{\text{DS}}, I_{\text{D}} = 250\mu\text{A}$	1		3	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 30\text{A}$		1.6	2	$\text{m}\Omega$
		$V_{\text{GS}} = 4.5\text{V}, I_{\text{D}} = 30\text{A}$		2	3	$\text{m}\Omega$
Gate input resistance	$R_g$	f=1MHz,open Drain		2		$\Omega$
<b>Dynamic Characteristics<sup>c</sup></b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 15\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		7950		pF
Output Capacitance	$C_{\text{oss}}$			1055		pF
Reverse Transfer Capacitance	$C_{\text{rss}}$			740		pF
<b>Switching Characteristics<sup>c</sup></b>						
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 15\text{V}, I_{\text{D}} = 15\text{A}, V_{\text{GS}} = 4.5\text{V}, R_{\text{GEN}} = 1\Omega$		41	82	ns
Turn-On Rise Time	$t_r$			32	64	ns
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			92	184	ns
Turn-Off Fall Time	$t_f$			30	60	ns
Total Gate Charge	$Q_g$	$V_{\text{DS}} = 15\text{V}, I_{\text{D}} = 50\text{A}, V_{\text{GS}} = 4.5\text{V}$		96	125	nC
Gate-Source Charge	$Q_{\text{gs}}$			24		nC
Gate-Drain Charge	$Q_{\text{gd}}$			39		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Drain-Source Diode Forward Current	$I_S$				115	A
Drain-Source Diode Forward Voltage <sup>b</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{S}} = 30\text{A}$			1.2	V
Notes : a.Repetitive Rating : Pulse width limited by maximum junction temperature b.Pulse Test : Pulse Width < 300μs, Duty Cycle < 2% c.Guaranteed by design, not subject to production testing. d.L = 1mH, I <sub>AS</sub> = 40A, V <sub>DD</sub> = 24V, R <sub>G</sub> = 25Ω, Starting T <sub>J</sub> = 25 C						



# CEP20A03/CEB20A03

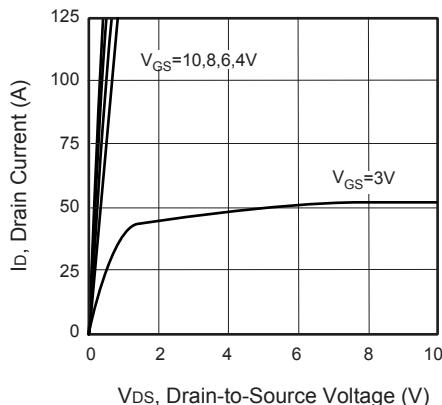


Figure 1. Output Characteristics

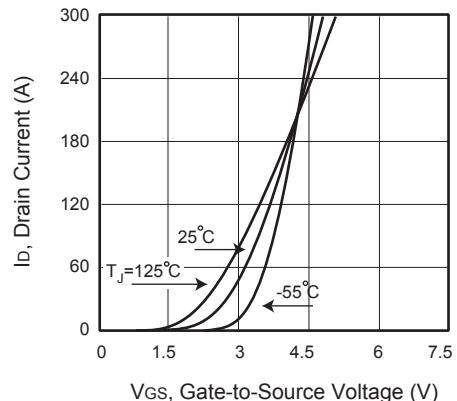


Figure 2. Transfer Characteristics

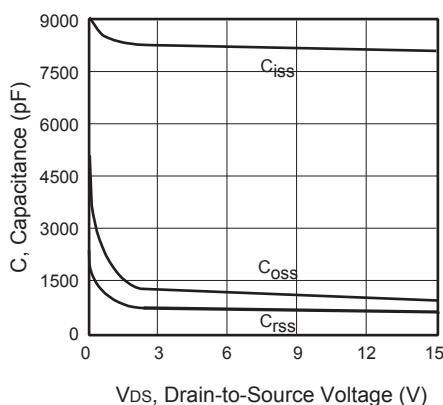


Figure 3. Capacitance

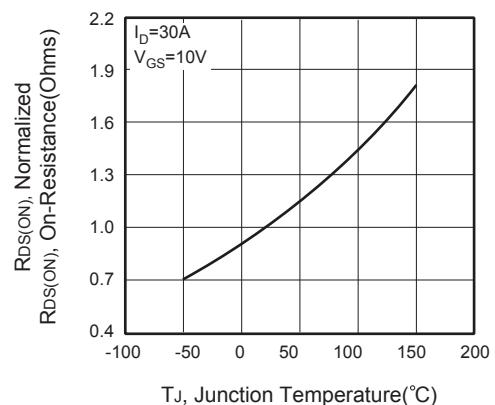


Figure 4. On-Resistance Variation with Temperature

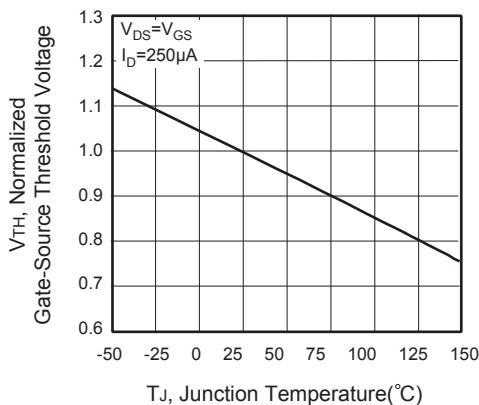


Figure 5. Gate Threshold Variation with Temperature

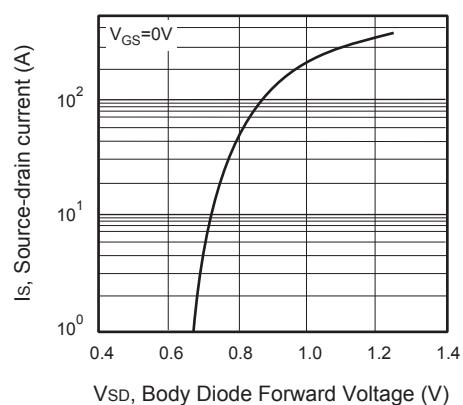


Figure 6. Body Diode Forward Voltage Variation with Source Current



# CEP20A03/CEB20A03

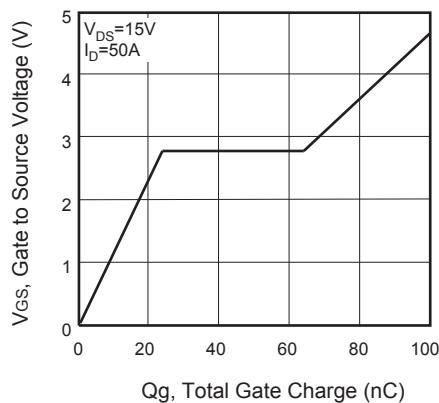


Figure 7. Gate Charge

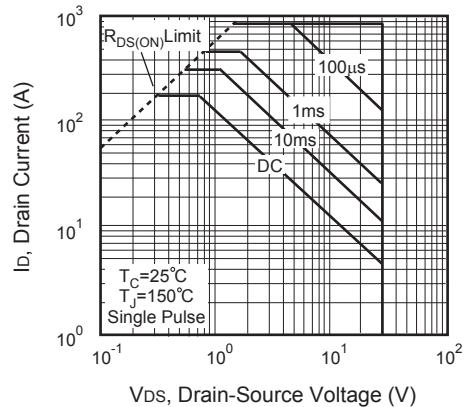


Figure 8. Maximum Safe Operating Area

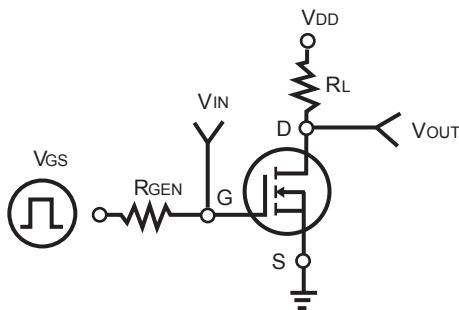


Figure 9. Switching Test Circuit

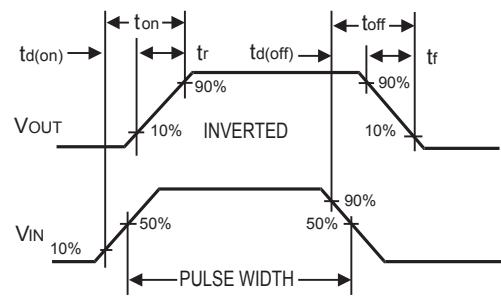


Figure 10. Switching Waveforms

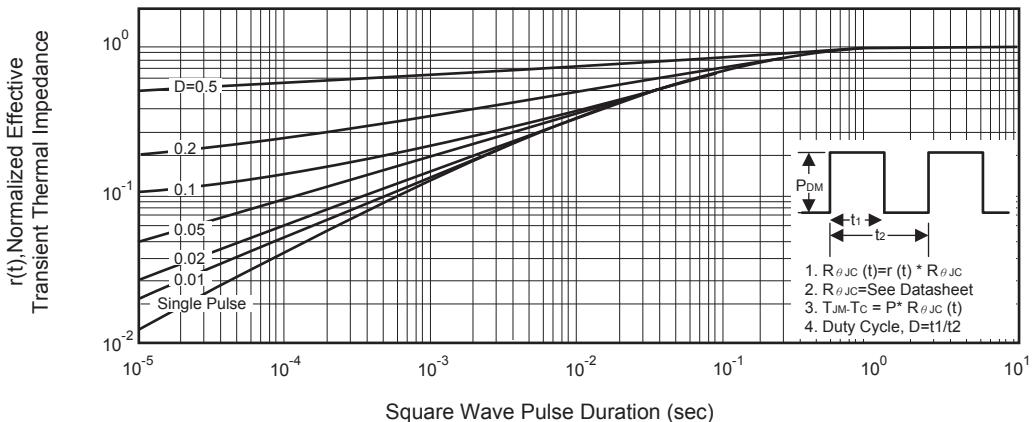


Figure 11. Normalized Thermal Transient Impedance Curve